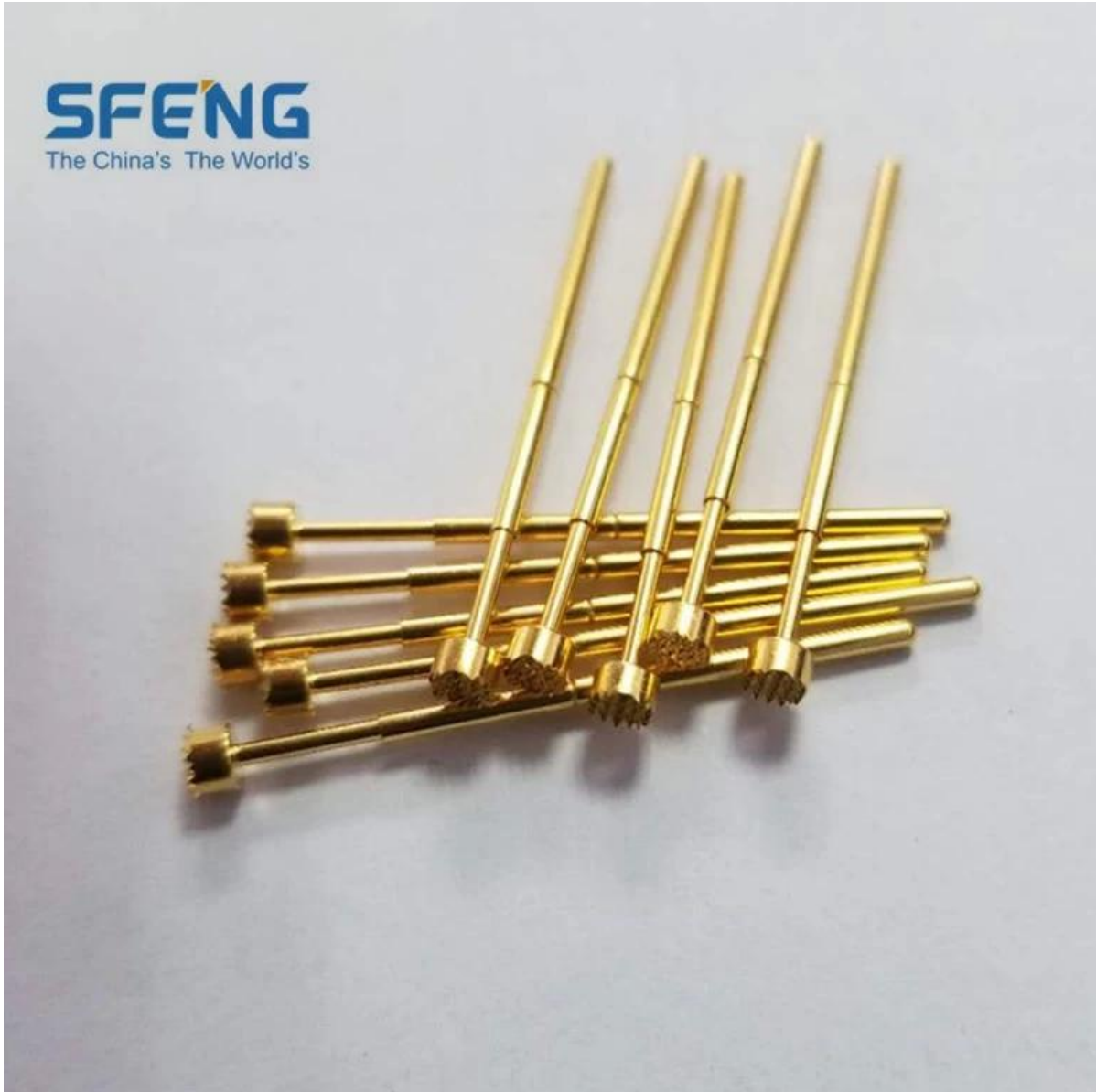


25 tips ICT test probe SF-PA100-H3.0

Product Specification

Brand	SFENG
Item number	SF-P100 series
Plating	Ni-plated or Gold-plated
Lead time	7 working days after receiving the payment



SF-P100

-A

-U

-H3.0

-B

-V

-LM

-J

-G

-T

-D

-H

-Q

-E

-H2.0

-B3

-U3

-H2.5

-B7

SF-P100-E

Probe specifications SF-P100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670")
电木板、玻璃纤维板: 1.75mm(.0689")
- Full travel(行程): 6.40(.2520")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰):
Plunger: Be Cu, Rh plated; SK4, Rh plated
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)

Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

SF-R100

SF-R100-SC

SF-R100-VCR2.5

SF-R100-CR

SF-R100-VW2.5(T)

SF-R100-WW双环2.5(T)

SF-R100-WW双环5.0(T)

SF-R100-WW双环(T)

SF-R100-VSC2.5

SF-R100-WW

SF-R100-WW(双环2.5)

SF-R100-WW(双环)

SF-R100-VW2.5

Probe specifications SF-R100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670")
电木板、玻璃纤维板: 1.75mm(.0689")
- Materials and finishes(材料及涂饰):
Barrel: Brass, Gold plated
- Connections(接线形式):
Crimp: R100-VCR2.5, R100-CR
Solder cup: R100-VSC2.5, R100-SC
Wire wrap: R100-VW2.5, R100-WW
R100-WW(双环2.5), R100-WW(双环)
Terminal: R100-VW2.5(T), R100-WW双环2.5(T), R100-WW双环5.0(T), R100-WW双环(T)

Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

Our Service

1. We can reply your inquiry within 24 working hours.
2. Customized design is available and OEM are welcomed.
3. We can deliver the probe pins to our clients all over the world with speed and precision.
4. We can provide the lowest price with high quality product to our client.

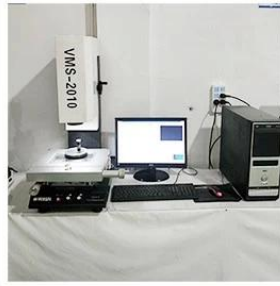
Main Products

- Spring loaded pin (single) for PCB, ICT, FCT testing etc;
- Pogo pin (connector) to establish connection between two printed circuit boards for charging, locating, Battery, Semiconductor & Interconnect applications;
- Double ended probe for BGA and Semiconductor testing;
- Universal pin without spring, coating pin, LM pin with QZ and VZ series;
- High current probe, Switch probe, Capacitance needle;
- Terminal & receptacle /socket;
- Other related electronic components, 30# OK wire, Jig locks, POM, Iron hinge etc

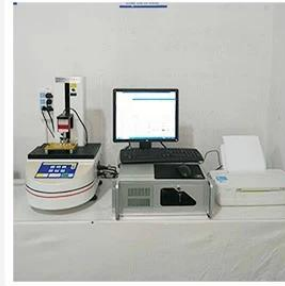
Quality Control



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Packing Picture

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

